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Domain and Structural Engineering of Ferroelectric Thin Films

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Message from the Guest Editor

Dear Colleagues,

We are pleased to invite you to submit your research papers to this Special Issue, entitled “Domain and Structural Engineering of Ferroelectric Thin Films”, which will be published in *Materials*.

Ferroelectric thin films have been widely researched for various applications such as non-volatile random access memories, actuators, sensors, waveguides, piezoelectric power generators, solar cells, flexible devices, etc. Domain and structure engineering of ferroelectric thin films is one of main issues to enhance physical properties, as well as device efficiencies, related to ferroelectric thin films.

If you have any questions, please do not hesitate to contact me.

Prof. Jong Yeog Son
Guest Editor



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Special Issue



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Message from the Editor-in-Chief

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